

TOSHIBA Photo Coupler GaAs Ired & Photo-Triac

TLP666G

Office machine

Household use equipment

Triac driver

Solid State Relay

The TOSHIBA TLP666G consists of a zero voltage crossing turn-on photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP.

- Peak off-state voltage: 400V(min.)
- Trigger LED current: 10mA(max.)
- On-state current: 100mA(max.)
- UL recognized: UL1577, file no. E67349
- Isolation voltage: 5000Vrms(min.)
- Option(D4) type

VDE approved: DIN VDE0884/08.87,

Certificate no.68383

Maximum operating insulation voltage: 630VPK

Highest permissible over voltage: 6000VPK

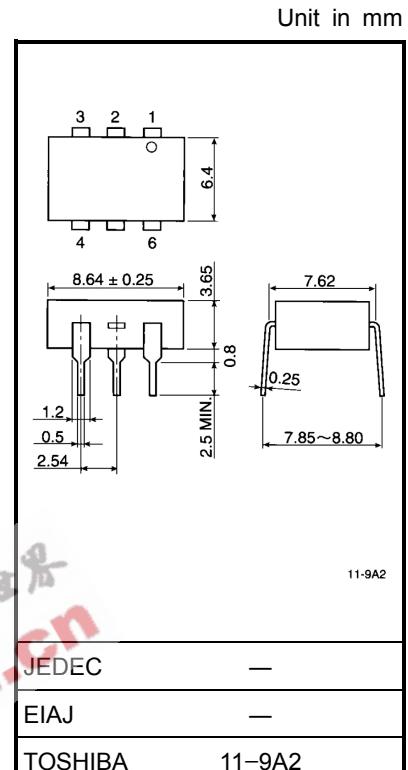
**(Note 1) When a VDE0884 approved type is needed,
please designate the "option(D4)"**

- Structural parameter

Creepage distance: 7.0mm(min.)

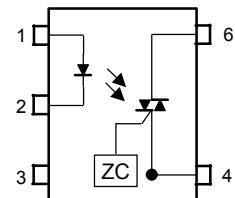
Clearance: 7.0mm(min.)

Insulation thickness: 0.5mm(min.)



Weight: 0.44 g

Pin Configurations (top view)



- 1 : Anode
- 2 : Cathode
- 3 : N.C.
- 4 : Terminal 1
- 6 : Terminal 2

Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
LED	Forward current	I _F	50	mA
	Forward current derating (Ta ≥ 53°C)	ΔI _F / °C	-0.7	mA / °C
	Peak forward current (100μs pulse, 100pps)	I _{FP}	1	A
	Reverse voltage	V _R	5	V
	Junction temperature	T _j	125	°C
Detector	Off-state output terminal voltage	V _{DRM}	400	V
	On-state RMS current	I _{T(RMS)}	100	mA
	Ta=70°C		50	
	On-state current derating (Ta ≥ 25°C)	ΔI _T / °C	-1.1	mA / °C
	Peak on-state current (100μs pulse, 120pps)	I _{TP}	2	A
	Peak nonrepetitive surge current (P _W =10ms, DC=10%)	I _{TSM}	1.2	A
	Junction temperature	T _j	115	°C
	Storage temperature range	T _{stg}	-55~125	°C
Operating temperature range		T _{opr}	-40~100	°C
Lead solder temperature (10s)		T _{sold}	260	°C
Isolation voltage (AC, 1min., R.H.≤ 60%) (Note 2)		BVs	5000	V _{rms}

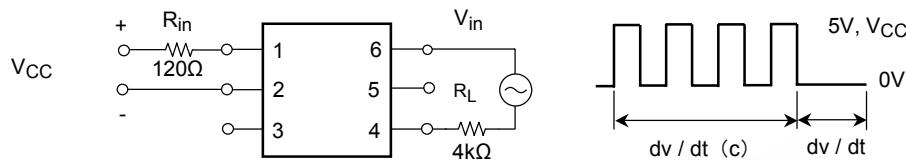
(Note 2) Pins 1,2 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

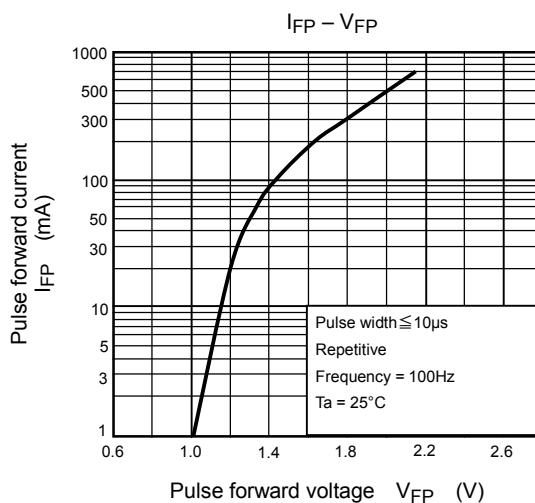
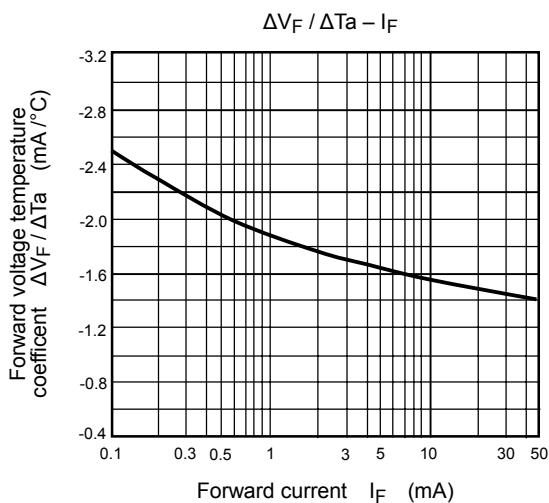
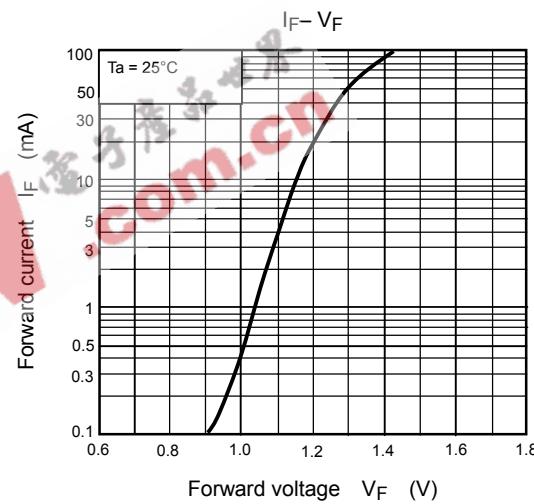
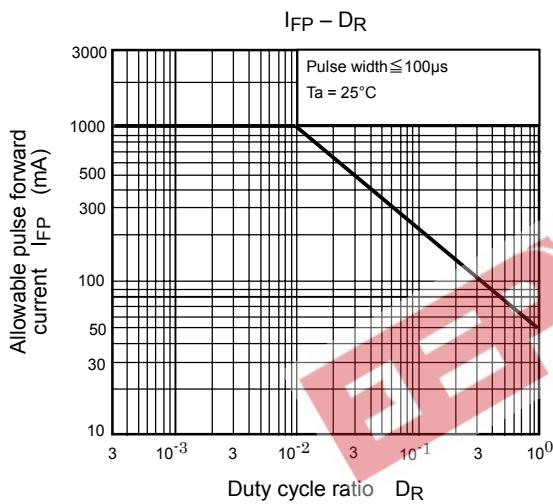
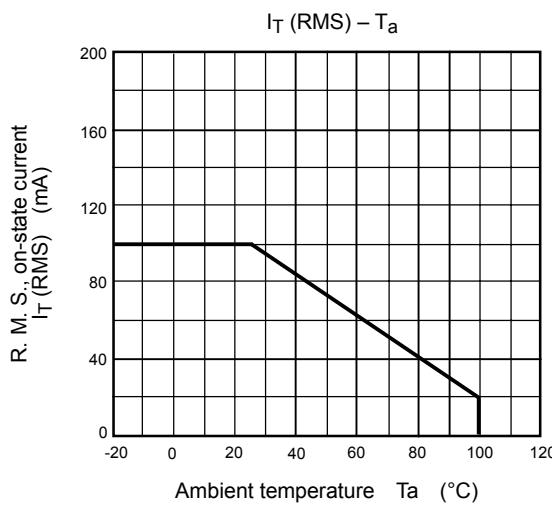
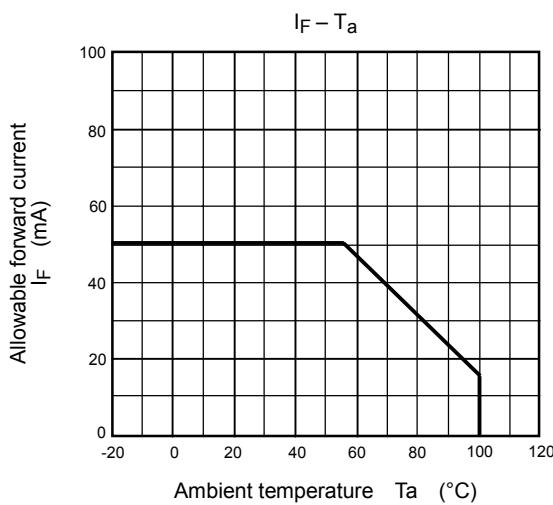
Characteristic	Symbol	Min.	Typ.	Max.	Unit
Supply voltage	V _{AC}	—	—	120	Vac
Forward current	I _F	15	20	25	mA
Peak on-state current	I _{TP}	—	—	1	A
Operating temperature	T _{opr}	-25	—	85	°C

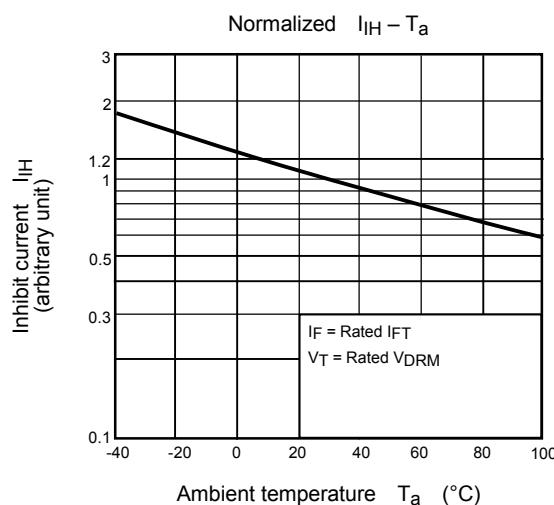
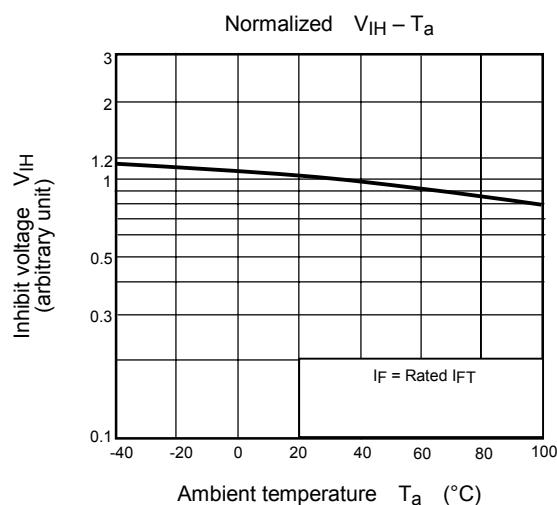
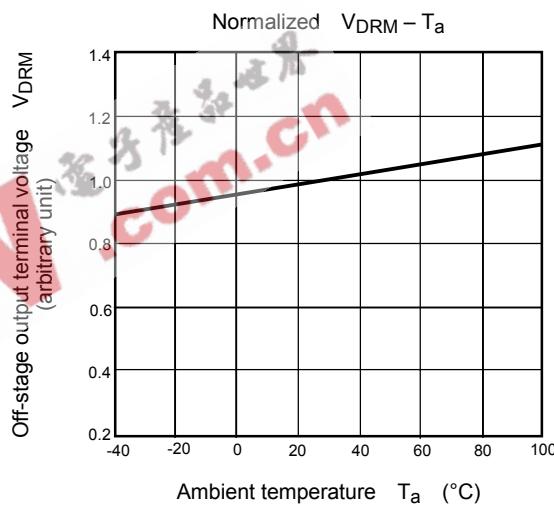
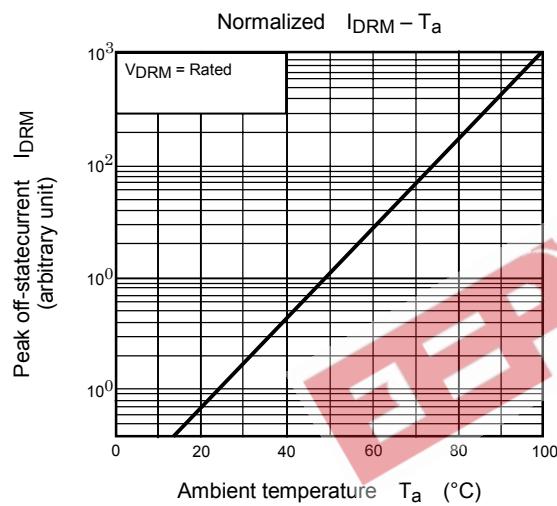
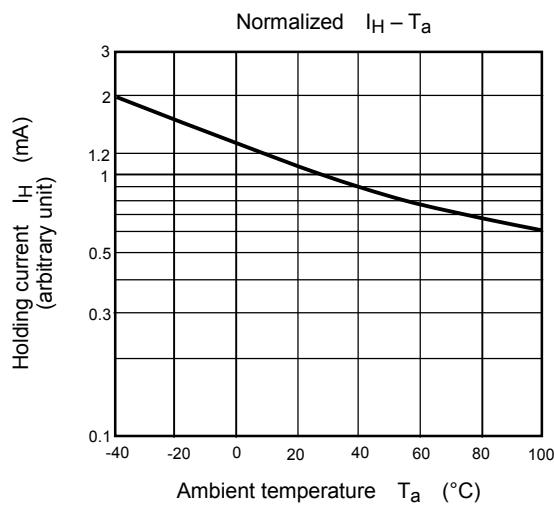
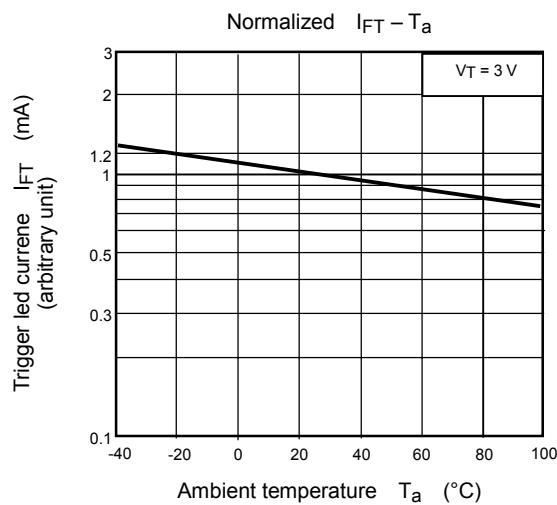
Electrical Characteristics ($T_a = 25^\circ C$)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
LED	Forward voltage	V_F	$I_F=10\text{mA}$	1.0	1.15	1.3	V
	Reverse current	I_R	$V_R=5\text{V}$	—	—	10	μA
	Capacitance	C_T	$V=0, f=1\text{MHz}$	—	30	—	pF
Detector	Peak off-state current	I_{DRM}	$V_{DRM}=400\text{V}$	—	10	100	nA
	Peak on-state voltage	V_{TM}	$I_{TM}=100\text{mA}$	—	1.7	3.0	V
	Holding current	I_H	—	—	0.6	—	mA
	Critical rate of rise of off-state voltage	dv / dt	$V_{in}=120\text{V}_{rms}, T_a=85^\circ C$ (Note 3)	200	500	—	$\text{V} / \mu\text{s}$
	Critical rate of rise of commutating voltage	$dv/dt(c)$	$V_{in}=30\text{V}_{rms}, I_T=15\text{mA}$ (Note 3)	—	0.2	—	$\text{V} / \mu\text{s}$

(Note 3) dv / dt test circuitCoupled Electrical Characteristics ($T_a = 25^\circ C$)

Characteristic		Symbol	Test Condition	Min.	Typ.	Max.	Unit
Trigger LED current	I_{FT}	$V_T=3\text{V}$	—	5	10	—	mA
Inhibit voltage	V_{IH}	$I_F=\text{rated } I_{FT}$	—	—	—	40	V
Leakage in inhibited state	I_{IH}	$I_F=\text{rated } I_{FT}$ $V_T=\text{rated } V_{DRM}$	—	100	300	—	μA
Capacitance (input to output)	C_S	$V_S=0, f=1\text{MHz}$	—	0.8	—	—	pF
Isolation resistance	R_S	$V_S=500\text{V}, R.H.\leq 60\%$	5×10^{12}	10^{14}	—	—	Ω
Isolation voltage	BVS	AC, 1 minute	5000	—	—	—	V_{rms}
		AC, 1 second, in oil	—	10000	—	—	
		DC, 1 minute, in oil	—	10000	—	—	Vdc





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